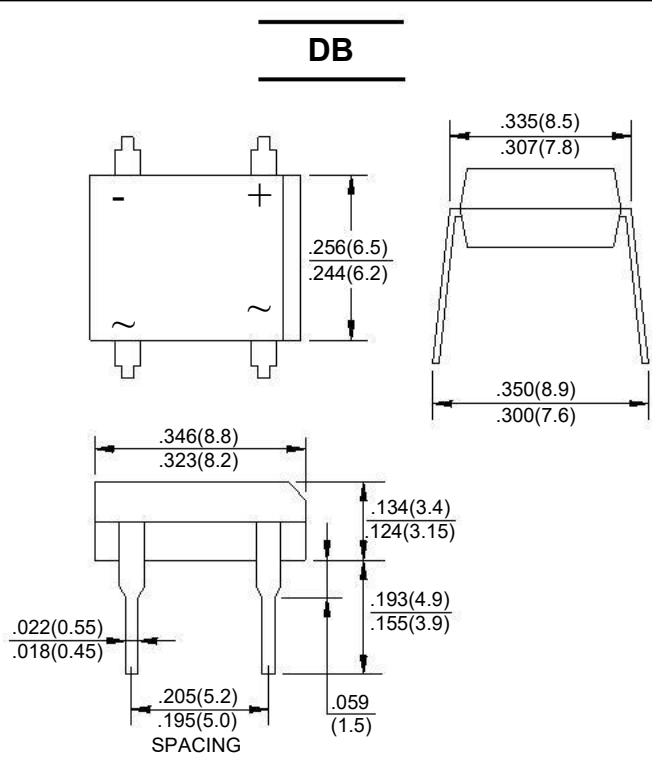


DB101 thru DB107

<p>GLASS PASSIVATED BRIDGE RECTIFIERS</p> <p>FEATURES</p> <ul style="list-style-type: none"> ● Rating to 1000V PRV ● Ideal for printed circuit board ● Low forward voltage drop, high current capability ● Reliable low cost construction utilizing molded plastic technique results in inexpensive product ● Lead tin Pb/Sn copper ● The plastic material has UL flammability classification 94V-0 <p>MECHANICAL DATA</p> <ul style="list-style-type: none"> ● Polarity: As marked on Body ● Weight: 0.02 ounces, 0.38 grams ● Mounting position: Any 	<p>REVERSE VOLTAGE - 50 to 1000 Volts FORWARD CURRENT - 1.0 Amperes</p> <p style="text-align: center;">DB</p>  <p style="text-align: center;">Dimensions in inches and (millimeters)</p>
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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	DB101	DB102	DB103	DB104	DB105	DB106	DB107	UNIT
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @T _A =40°C	I _(AV)	1.0							A
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load (JEDEC Method)	I _{FSM}	50							A
Maximum Forward Voltage at 1.0A DC	V _F	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage @T _J =25°C @T _J =125°C	I _R	10 500							uA
I _{2t} Rating for Fusing(t<8.3ms)	I _{2t}	10.4							A _{2s}
Typical Junction Capacitance Per Element(Note1)	C _J	25							pF
Typical Thermal Resistance (Note2)	R _{θJC}	40							°C/W
Operating Temperature Range	T _J	-55 to +150							°C
Storage Temperature Range	T _{STG}	-55 to +150							°C

Note: 1. Measured at 1.0MHz and applied reverse voltage of 4.0V DC
 2. Thermal resistance from junction to ambient mounted on P.C.B with 0.5*0.5"(13*13mm)copper pads.

FIG.1-FORWARD CURRENT DERATING CURVE

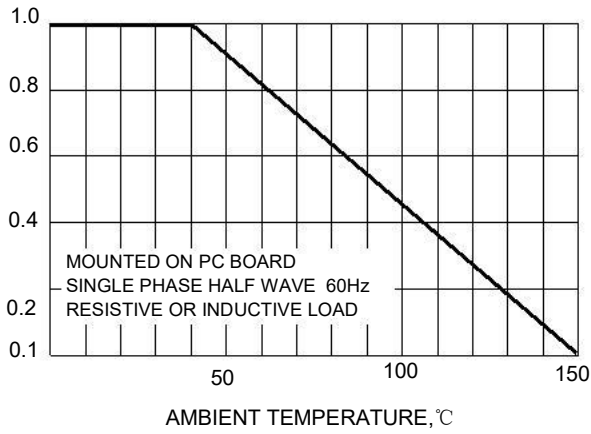


FIG.2-MXIMUM NON-REPETITIVE SURGE CURRENT

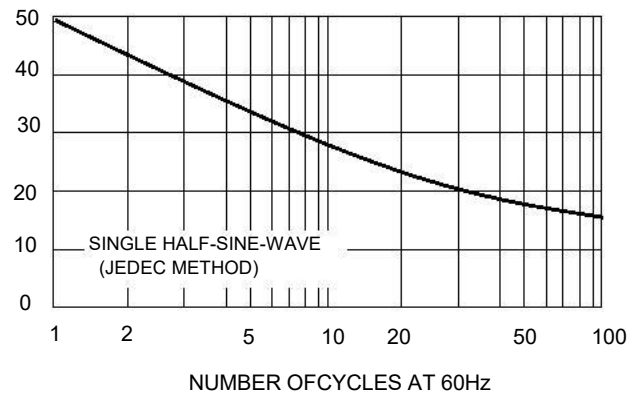


FIG.3-TYPICAL JUNCTION CAPACITANCE

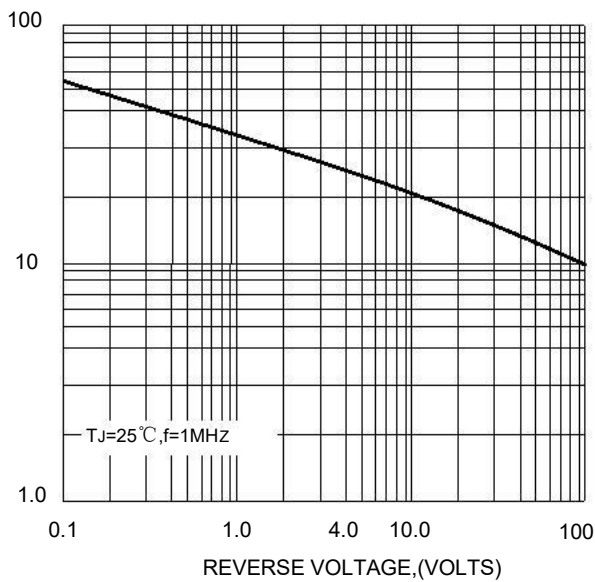


FIG.4-TYPICAL FORWARD CHARACTERISTICS

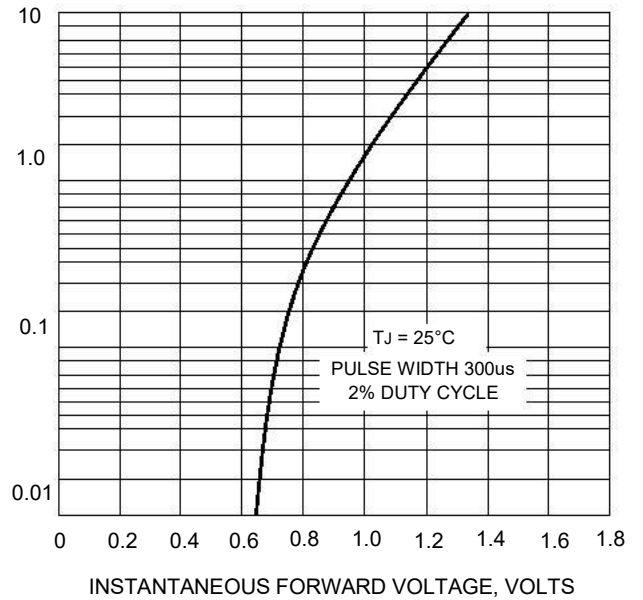


FIG.5-TYPICAL REVERSE CHARACTERISTICS

